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09/754,264 01/05/2001 Tetsuo Usami OKI. 7590 07/26/2004 JONES VOLENTINE, L.L.P.	202 3022 EXAMINER
	EXAMINER
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Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)
	09/754,264	USAMI ET AL.
Office Action Summary	Examiner	Art Unit
	Steven H. Rao	2814
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period of the period of the period of the period for reply will, by statute any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be tim y within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONEI	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).
Status		
1) Responsive to communication(s) filed on 20 M	<u>lay 2004</u> .	
2a)⊠ This action is FINAL . 2b)□ This	action is non-final.	
3) Since this application is in condition for allowant closed in accordance with the practice under E	·	
Disposition of Claims		
4) Claim(s) 10-15,17,18 and 20 is/are pending in 4a) Of the above claim(s) is/are withdray 5) Claim(s) is/are allowed. 6) Claim(s) 10-15, 17-18 &20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	wn from consideration.	
Application Papers		
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) acc Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Example 11.	epted or b) objected to by the E drawing(s) be held in abeyance. See tion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Burear * See the attached detailed Office action for a list	s have been received. s have been received in Application rity documents have been receive u (PCT Rule 17.2(a)).	on No ed in this National Stage
Attachment(s)	o□	(DTO 440)
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	

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Response to Amendment

Applicants' amendment faxed on May 14, 2004 has been entered on May 20, 2004.

Therefore claims 10-13, 15 17,18,20 as previously presented, Claim 14 as currently amended are currently pending in the Application.

Claims 16 and 19 have been cancelled.

With drawn Claims 1-9 must be cancelled see below.

Election/Restrictions

The listing of the claims in pages 3 to 5 of the amendment states claims

1-9 as withdrawn . However the preliminary amendment filed/ faxed on January

23, 2003 cancelled claims 1 to 9..

Therefore the Application currently does not contain claims 1-9.

Applicants' must acknowledge that claims 1–9 have been cancelled and not include these claims in future amendments.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 10-15, 17,18 and 20 are rejected under 35 U.S.C. 103(a) as being patentable over Wang (U.S. Patent No. 5,604,155, herein after Wang) in view of Fukui

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Soichi (Japanese Patent Publication No. 9-249966, herein after Soichi) both previously applied. For response to Applicants' arguments see section below.

With respect to claim 10, Wang describes a method of depositing a wiring film over a semiconductor substrate, the method comprising:

Wang does not specifically describe a Al ₃ Ti target

However Soichi in its table 2, no. 2 describes using Al ₃ Ti target to improve the reliability of the membrane(thin film) formed that can be used in optical media devices.

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to include Soichi's Al ₃ Ti target in Wang's method to improve the reliability of the membrane(thin film) formed that can be used in optical media devices. (Soichi Effect of the invention section and table 3).

The other limitations of claim 10 are:

providing a substrate (Wang col. 1 line 29), forming a Ti Layer over the substrate(Wang fig. 2 # 52, col. 4 lines 3-7), sputter depositing an Al ₃Ti layer on said Ti layer using said Al ₃Ti target (Soichi English –abstract) and annealing said substrate at a temperature of at least 400 °C to promote absorption of Si into said Al ₃Ti layer. (Wang fig.3 # 108, col. 4 lines 25-26, col. 3 lines 5-6).

With respect to claim 11, wherein an Al layer is deposited on said Al ₃Ti layer (Wang fig. 3, col. 4 lines 25-26).

With respect to claim 12, wherein the step of pattern-etching said Al layer thereby forming a wiring pattern. (Wang col. 2 lines 52-55).

With respect to claim 13, wherein the method further comprises forming an insulating layer between said substrate and said Al ₃Ti layer (Wang col. 1 lines 36-38).

With respect to claim 14, Wang describes a method of depositing a wiring film, the method comprising :

Providing a substrate (Wang col. 1 line 29), forming a Ti Layer over the substrate(Wang fig. 2 # 52, col. 4 lines 3-7), depositing an AlSiCu layer on said Ti layer which forms an Al3TI layer on said Ti Layer (Soichi English –abstract- the motivation to combine Wang and Soichi is given above) and pattern etching an AL lyaer which forms beneath said ALSICU layer. (Wang fig. 3 step 114).

With respect to claim 15, Wang describes the method as recited in claim 14, wherein said AISI CU layer is deposited at a temperature of at least 400 degrees C. (Wang fig.3 # 108, col. 4 lines 25-26, col. 3 lines 5-6).

With respect to claim 17 it repeats the steps of claim 10 and is rejected for reasons set out under claim 10 above.

With respect to claim 18, Wang teaches a method as recited in claim 17, wherein said AL layer is deposited at a temperature of at least 400° C (Wang fig.3 # 108, col. 4 lines 25-26, col. 3 lines 5-6).

With respect to claim 20 Wang describes a method as recited in claim 17, wherein said Al₃Ti layer is deposited at a temperature of at least 400^o C. (Wanf col. 4 lines 21 to 40).

Applicant's arguments filed 5/14/2004 have been fully considered but they are not persuasive for the following reasons :

Applicants' first contention that the rejection based on Soichi is improper is wholly incorrect for the following reasons :

1) The Soichi reference was first applied in a rejection mailed on April 07, 2003 (pages 4-5), wherein Soichi was cited quoting Table 2 no.2 as showing the use of Al_3 Ti target .

A response by Applicants' to the rejection mailed on April 07, 2003 accepting the citation of Soichi was received by the USPTO on August 07, 2003 wherein the issue of the Soichi reference Table 2 no. 2 being in the full-text of the document instead of the abstract was not raised and Applicants' were able to fully understand the rejection and respond to the rejection based on the combined teachings of Wang and Soichi containing the same citation (table 2 , no.2) as seen from Applicants' response of August 07, 2003 at least pages 7-8.

Based on the above Applicants' above acceptance of the Soichi full-text citation (table 2 no. 2) a rejection was mailed out on November 19, 2003.

It is not under stood, how Applicants' Applicants' have suddenly developed language problems for the Applied Soichi reference after Applicants' acceptance and procesution proceeding upon Applicants' acceptance.

2) It is noted that Soichi table 2 no.2 describing (Al₃ Ti) is in English Language (reproduced below) :

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		* 2	•			(建設:A18上以本可重不利的)		IMCの過度均配
*		INC粉末	AJ智末	IMC粉末	Age末	表面	2 1	(€# %/ ■)
	1	A43 Ta : 6. 0	16	A4 ₃ Ta : 4, 80	摄	A#3 Ta: 6. 0	A43 Ta:4. 80	0 20
*	2	Af ₃ Ti:8, 0	鹿	A# ₃ Ti : 6. 40	聂	A#3 T : 8. 0	A43 Ti: 6. 40	D 27
発	3	A#3 2::4, 0	克	A4, Zr : 3. 34	菔	A#g Zr:4. 0	A63 2 r : 3. 04	0 16
朝	4	A#3 Hf: 2. 0	基	A43 H1:1. 52	摄	A#3 Ht: 2, 0	A#3 Hf: 1. 52	0 08
9	į	A4g Nb:4. 0	Æ	A#3 Nb : 3. 04	Ħ	AZ3 Nb : 4. 0	A#3 Nb: 3. 04	3 18
1.	6	A#4 Cr: 10. 0	基	A#4 Cr : 7. 90	題	A#4 Cr : 10. 0	A64 Cr : 7. 90	J 35
if	7	A#4W: 15. 0	胜	A & W: 10, 50	費	AF W: 15. 0	AF ₄ W:10, 50	0.75
ŋ	8	A# Mo : 20, 0	Ħ	A#4 Mp:12, 50	Ħ	A#4M6:20. 0	A#4 Mo: 12. 50	1. 25 -
۲	9	A#3 Tez :12. 5	丑	Adg Tag : 11. 00	丑	AF3 Ta2:12. 5	A#g Ta; :11.00	0. 25
	10	A#3 Ta : 2. 0	Ħ	A#3 Ta:1. 88	Ħ	A4 Ta: 2. C	Afg Ta: 1. 88	0. 02

- 3) It is noted that the Applicants' herein are Tesuo Usami and Yoshikawa Arakawa are both native Japanese language speakers and can easily read and understand the entire Soichi reference in Japanese language and further the deceleration herein is also in Japanese.
 - 4) Therefore Soichi is properly applied as a reference.

Therefore the rejection of claim 10 and dependent claims 11-13 is proper and made Final.

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Applicants' second argument with respect to claim 14 that Wang does not teach/describe the step of " pattern etching an Al layer, which forms beneath said Al-Si-Cu layer and after depositing of the Al-SI-Cu layer, annealing the substrate at a temperature of at least 400° C" is not persuasive because Wang col. 2 lines 36-37 describe the annealing step at 450 ° C but not in the order presently recited in the claims.

However, as stated before, it is well settled law that, "As a matter of fact selection of any order of performing process steps is prima facie obvious in the absence of new or unexpected results. In re Burhaus, 154 F.2d 690, 69 USPQ 330 (CCPA 1946) Further, "generally, Applicants' reversed order of process sequence as compared to Wang's, can not be considered as a an act of invention, since reversing the order of prior art process step is held to render prima facie obvious. Ex parte Rubin, 126 USPQ 440 (BAPI 1959).

Therefore none of Applicants' arguments are persuasive and all pending claims are finally rejected.

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any

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extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communication from the examiner should be directed to Steven H. Rao whose telephone number is (703) 306-5584. The examiner can normally be reached on Monday- Friday from approximately 7:00 a.m. to 5:30 p.m.

Any inquiry of a general nature or relating to the status of this application should be directed to the Group receptionist whose telephone number is (703) 308-0956. The Group facsimile number is (703) 308-7724.

Steven H. Rao

Patent Examiner

July 21, 2004.

FRIMARY EXAMINER